

200V N-Channel Enhancement Mode MOSFET

Description

The AP40N20P/T is silicon N-channel Enhanced

VDMOSFETs, is obtained by the self-aligned planar Technology

which reduce the conduction loss, improve switching

performance and enhance the avalanche energy. The transistor

can be used in various power switching circuit for system

miniaturization and higher efficiency.

General Features

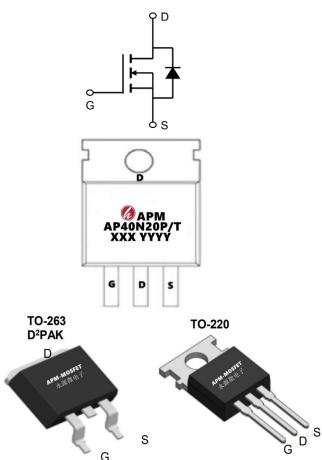
V_{DS} = 200V I_D =40A

 $R_{DS(ON)} < 65m\Omega @ V_{GS}=10V$ (Type: 50m Ω)

Application

Uninterruptible Power Supply(UPS)

Power Factor Correction (PFC)



Package Marking and Ordering Information

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Product ID	Pack	Marking	Qty(PCS)	
AP40N20T	TO-263-3L	AP40N20T XXX YYYY	800	
AP40N20P	TO-220-3L	AP40N20P XXX YYYY	1000	

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
VDSS	Drain-Source Voltage	200	V
ID	Drain Current -continuous	40	А
IDM	Drain Current -pulse	112	А
VGSS	Gate-Source Voltage	±30	V
EAS	Single Pulsed Avalanche Energy	588	mJ
IAR	Avalanche Current	28	А
EAR	Repetitive Avalanche Current	15.8	mJ
dv/dt	Peak Diode Recovery dv/dt	5.5	V/ns
PD TC=25°C	Power Dissipation	158	W
TJ, TSTG	Operating and Storage Temperature Range	-55~+150	°C
TL	Maximum Lead Temperature for Soldering Purposes	300	°C
Rth(j-c)	Thermal Resistance, Junction to Case	0.79	°C/W
Rth(j-A)	Thermal Resistance, Junction to Ambient	62.5	°C/W



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Electrical Characteristics (T_J=25°C, unless otherwise noted)

Symbol	Parameter	Tests conditions	Min	Тур	Мах	Units
BV _{DSS}	Drain-Source Voltage	I _D =250μΑ, V _{GS} =0V	200	-	-	V
IDSS	Zero Gate Voltage Drain Current	V _{DS} =200V, V _{GS} =0V,T _C =25 _℃	-	-	1	μA
IGSSF	Gate-body leakage current, forward	V _{DS} =0V, V _{GS} =30V	-	-	100	nA
IGSSR	Gate-body leakage current, reverse	V _{DS} =0V, V _{GS} =-30V	-	-	-100	nA
VGS(th)	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D =250µA	2.0	3.0	4.0	V
RDS(ON)	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =14.0A	-	50	65	mΩ
g fs	Forward Transconductance	V _{DS} = 40V , I _D =14.0A	-	24	-	S
C _{iss}	Input capacitance		-	2879	3742	pF
Coss	Output capacitance	V _{DS} =25V, V _{GS} =0V, f=1.0MHz	-	362	470	pF
Crss	Reverse transfer capacitance		-	81	105	pF
t _d (on)	Turn-On delay time	V _{DD} =100V,I _D =28A,R _G =25Ω V _{GS} =10V	-	28	69	ns
tr	Turn-On rise time		-	251	494	ns
t _d (off)	Turn-Off delay time	(note 4, 5)	-	309	617	ns
t _f	Turn-Off Fall time		-	220	412	ns
Qg	Total Gate Charge		-	103	136	nC
Q_gs	Gate-Source charge	V _{DS} =160V , I _D =28A V _{GS} =10V	-	16	-	nC
Q_{gd}	Gate-Drain charge		-	53	-	nC
IS	Continuous Body Diode Current	T 05.00	-	-	28	Α
ISM	Pulsed Diode Forward Current	– T _C = 25 °C	-	-	112	Α
VSD	Body Diode Voltage	V _{GS} =0V, I _S =28A	-		1.4	V
trr	Reverse recovery time			218		ns
Qrr	Reverse recovery charge	- V _{GS} =0V, I _S =28A dI _F /dt=100A/μs		1.91		μC

Note :

 $1_{\mbox{\tiny V}}$ The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper.

2、The EAS data shows Max. rating . L=1.5mH, I_{\rm As}=28A, V_D=50V, R_G=25 Ω , Starting T_=25°C

3、The test condition is Pulse Test: Pulse width \leq 300µs, Duty Cycle \leq 1%

4. The power dissipation is limited by 150° C junction temperature

5、The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.

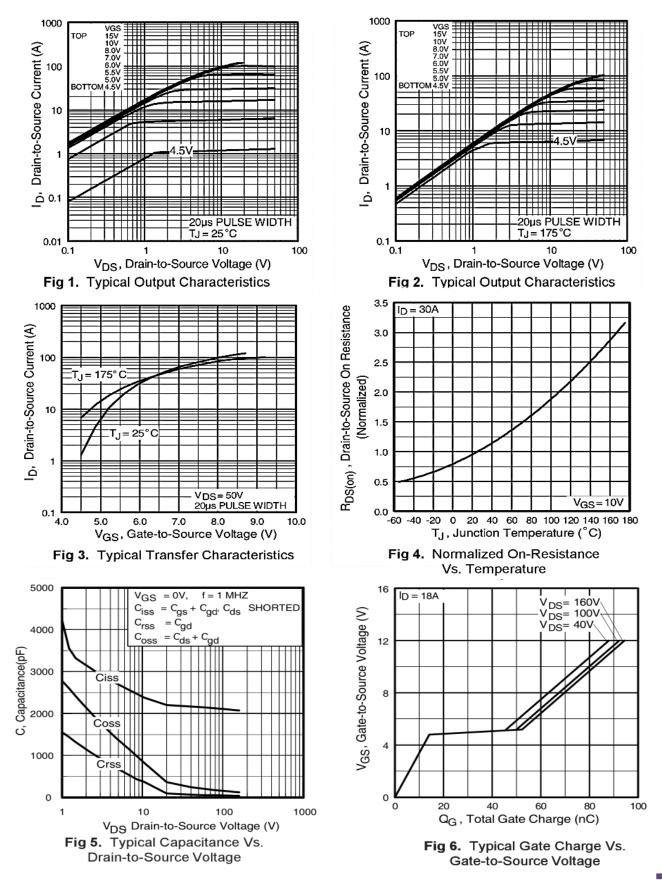
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AP40N20P/T

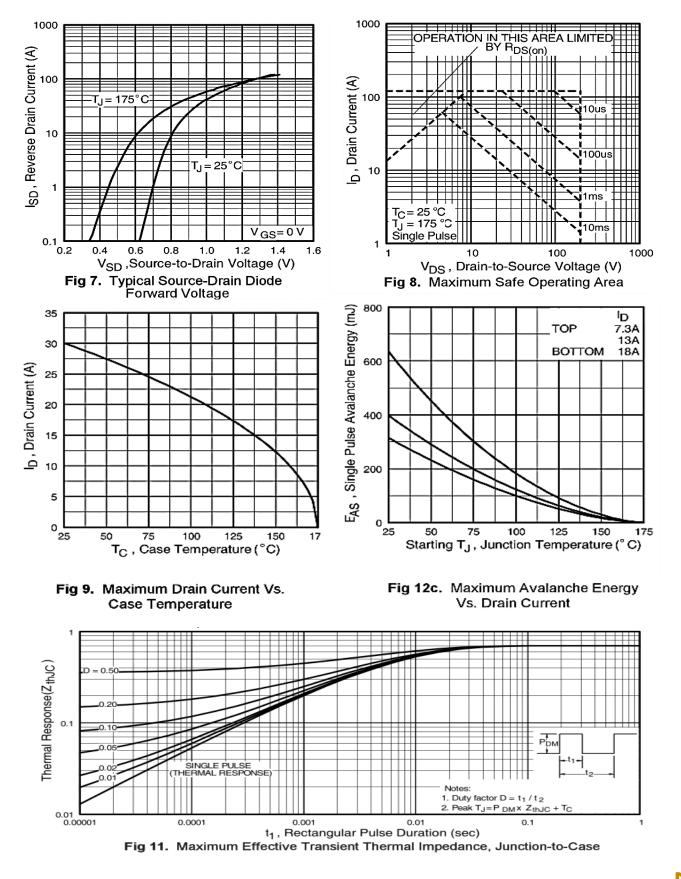
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Electrical Characteristics





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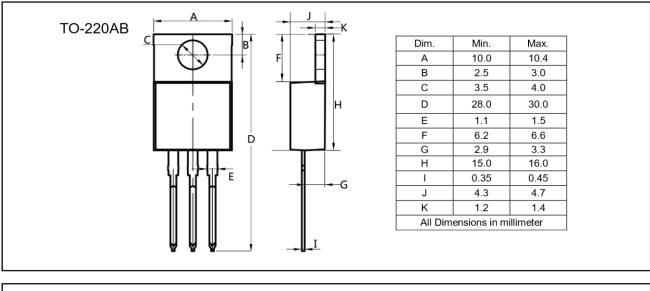


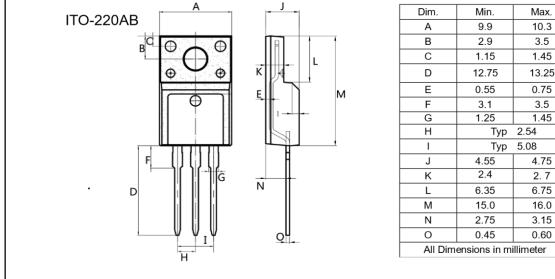
AP40N20P/T RVE1.0

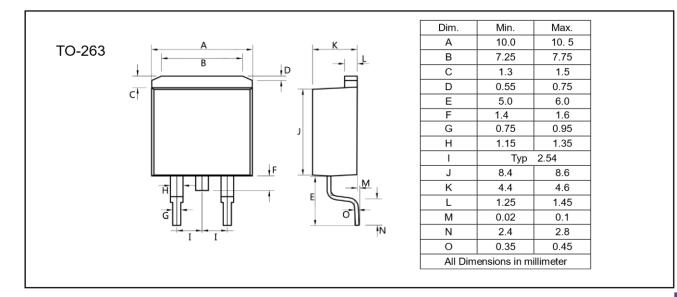
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Edition	Date	Change
Rve1.0	2019/1/31	Initial release

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